RTE-VR5432-CB

USER'S MANUAL (Rev. 2.01)

Midas lab

Date	Revision	Explanation of revision	
August 15, 1999	1.00	Official 1st edition	
September 15, 1999	1.01	Modification of current consumption from 2.5A (max.) to 2.0A (max.)	
December 29,1999	2.00	 Change accompanied by specification change (specification change of the bus in Big Endian) for H/W version Rev.2.00 The chapter and section which were changed are as follows. The description part concerning BigEndian to each. 7.3 Address Map 9 ROM Programming 	
April 12,2000	2.01	Clerical error correction 5.16 CPU Connectors (JCP1, 2) The maker of a connector is corrected to hirose from KEL. 10.3 Chip Select Logical address range value is corrected.	

REVISION HISTORY

Notes

The specification in the case of using RTE-VR5432-CB by Big Endian in H/W Rev.2 was changed. H/W Rev.1:Byte-Swap is implemented.

H/W Rev.2:Byte Swap is not implemented.

Therefore, how to write in access to I/O space and ROM is changed.

About this point, it is not compatible.

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1. INTRODUCTION

The RTE-VR5432-CB is a CPU board that is designed to evaluate the NEC RISC processor.

The board features a VR5432 CPU capable of operating at a maximum speed of 167 MHz, memory, serial/parallel interface, and bus connector for expansion. As the memories, a high-speed PB-SRAM and high-capacity SDRAM are provided as standard.

These functions enable the RTE-VR5432-CB to be used for a wide variety of applications including processor performance evaluation and application program development at the initial stage, and to also be used as an engine for demonstration and simulation.

The GHS Multi or NEC PARTNER source-level debugger can be used as a development software tool with the RTE-VR5432-CB. The type of monitor to be stored in ROM depends on the debugger type. In ROM, the monitor specified at the time of purchase is stored. Even when neither of the debuggers is purchased together with the RTE-VR5432-CB, they can be purchased at anytime subsequently.

1.1. NUMERIC NOTATION

This manual represents numbers according to the notation described in the following table. Hexadecimal and binary numbers may be hyphenated at every four digits, if they are difficult to read because of many digits being in each number.

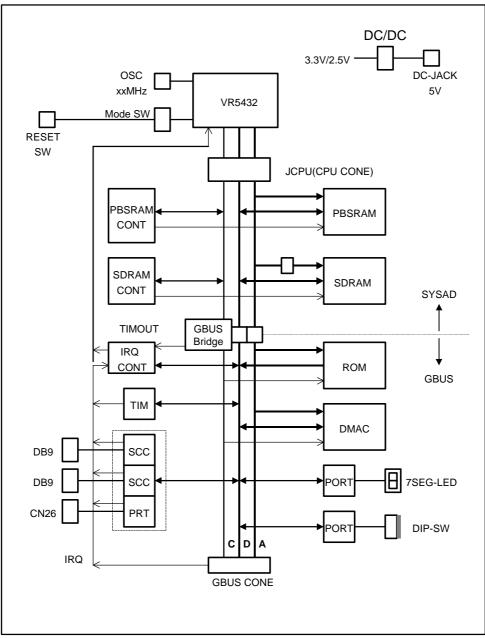
Number	Notation rule	Example
Decimal number	Only numerals are indicated.	"10" represents number 10 in decimal.
Hexadecimal number	A number is suffixed with letter H.	"10H" represents number 16 in decimal.
Binary number	A number is suffixed with letter B.	"10B" represents number 2 in decimal.

Number Notation Rules

Multi is a trademark of Green Hills Software, Inc. in the US.

2. FUNCTIONS

The overview of each function block of the RTE-VR5432-CB is shown below.



RTE-VR5432-CB Block Diagram

3. MAJOR FEATURES

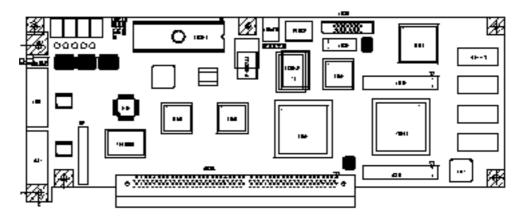
- Two types of monitor ROM are provided: one is used for the GreenHills Multi and the other for the NEC PARTNER.
- Real-time execution and evaluation at a high-level language level are possible.
- 256 Kbytes of PB-SRAM and 64 Mbytes of SDRAM are provided as standard.
- Two interfaces are provided: Serial (2 channels) and parallel (IEE1284).
- A ROM emulator and N-Wire tool can be connected.

4. BASIC SPECIFICATIONS

Processor	VR5432	
CPU clock	150 MHz (167 MHz max.)	
Bus clock	60 MHz (max.)	
Power supply	+5 V, 2.0 A (max.)	
Memory		
EPROM	256 KB 128 K \times 16 bits (40-pin DIP) \times 1 (512 Kbytes max.)	
PB-SRAM	256 KB 32 K × 32 bits × 2	
SDRAM	64 MB 4 M \times 4 bits \times 4 banks \times 8	
I/O		
Serial interface	Equivalent to NS16550, DB9 connector $ imes$ 2 channels	
Parallel interface	IEEE1284 compatible, CON26 connector	
Timer	mPD71054, 500-ns resolution	
I/O port	LED (7 segment) display/switch input	
Others		
CPU connector	Connector connecting all VR5432 pins	
GBUS connector	RTE-CB compliant 32-bit I/F (4-GB, 32-bit bus, supporting DMA)	
Reset switch	Push type	

5. BOARD CONFIGURATION

The physical layout of the major components on the RTE-VR5432-CB board is shown below. This chapter explains each component.





5.1. RESET SWITCH (SW_RESET)

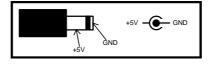
SW_RESET is a reset switch for the entire board. Pressing this switch causes all the circuits including the CPU to be reset.

5.2. POWER CONNECTOR (JPOWER)

The power supplied to the JPOWER connector should be one rated as listed below.

Voltage:	+5 V
Current:	Maximum of 2.0 A
Mating connector:	Type A (5.5 mm in diameter)

Polarity:



Note the polarity when attaching the power connector. To supply power from the JGBUS connector, do not connect a power source to JPOWER.

5.3. SWITCH 1 (SW1)

SW1 is a general-purpose input port switch. The setting status can be read from an input port (see **7.4.4 SW1 Read Port (SW1 B800-0000H [Read Only])**). When the port is read, a switch being set to OFF represents 1, while its being set to ON represents 0. When the monitor ROM is used, all SW1 switches except some are already set. Set this switch for assignment with the monitor ROM by referring to the following sections and in accordance with your environment:

When using Multi, see 11.1.2 SW1 Setting.

When using PARTNER, see 12.1.1 SW1 Setting.

5.4. SWITCH 2 (SW2)

SW2 selects an operation of the board by hardware. The setting of the switch can be read from an input port (see **7.4.5 SW2 Read Port (SW2 B800 to 1000H [Read Only])**).

No.	Signal name	Factory setting	Function
1	FBOOT	OFF	Specifies resources to be allocated to the CS0 space. OFF: The on-board UV-EPROM is allocated to the CS0 space. ON: GCS1- space of GBUS is allocated to the CS0 space (see 10.3 CHIP SELECT).
2	TEST1	OFF	Set this signal to OFF.
3	BCLK_LOW	OFF	Selects frequency of oscillator mounted on OSC1. Depending on the value set, the monitor ROM changes the number of ROM and SRAM wait cycles. In addition, the number of I/O wait cycles is changed by hardware. OFF: Bus clock exceeds 33 MHz. ON: Bus clock is kept at 33 MHz or less.
4	DDDD	OFF	Specifies the write data rate. The Config register of the VR5432 must be set according to the value set here. OFF: DxxDxxDxxDxx ON: DDDD
5	TESET2	OFF	Must be set to OFF.
6	Not used	OFF	Must be set to OFF.
7	Not used	OFF	Must be set to OFF.
8	GCLK LOW	OFF	Must be set to OFF.

5.5. SWITCH 3 (SW3)

SW3 selects the type of ROM inserted in the ROM socket and performs setting related to banks.

No.	Signal name	Factory setting	Function	
1	ROM_TYPE0	OFF	Selects the type of ROM. [ROM_TYPE1, ROM_TYPE0] [OFF , OFF]: When monitor ROM is used	
2	ROM_TYPE1	OFF	[OFF , ON]: When 27C4096 is used [ON , OFF]: When 27C2048 is used [ON , ON]: When 27C1024 is used	
3	BANK_DIS	OFF	Specifies whether the upper and lower halves (banks) of ROM are separated. Be sure to set this signal to OFF when monitor is used. OFF: Upper and lower halves of ROM are separated. ON: Upper and lower halves of ROM are used as a contiguous area.	
4	Not used	OFF	Must be set to OFF.	
5	Not used	OFF	Must be set to OFF.	
6	Not used	OFF	Must be set to OFF.	
7	MON64	OFF	Specifies the monitor type. OFF: 32-bit mode ON: 64-bit mode	
8	LITTLE	OFF	Specifies the endian. OFF: Big endian ON: Little endian	

Remark If connecting a ROM emulator, set BANK_DIS to ON, and perform the setting to use the ROMs as a continuous ROM space. (See **9.2 ROM DATA ASSIGNMENT**)

5.6. SWITCH 4 (SW4)

SW4 specifies the mode of a CPU pin. When a signal of this switch is set to OFF, the corresponding CPU pin is 1; when it is set to ON, the pin is 0.

SW4 DivMode [10] Ratio		DivMode [10] Ratio	Remark (* indicates factory-setting)
1	2		
ON	ON	0: 2:1	
OFF	ON	1:2.5:1	*
ON	OFF	2: 3:1	
OFF	OFF	3: 4:1	

SW 4-3 is always fixed to OFF.

SW 4-4 is for testing. Always fix it to OFF.

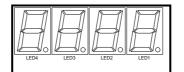
5.7. SWITCH 5 (SW5)

SW5 physically cuts the board's signal lines connected to CPU pins. All the switches are factory-set to ON (connected). The factory setting should be used in normal cases.

No.	CPU pin name	Factory setting	Internally used resource
1	Not used	OFF	
2	INT2-	ON	GINT1- of GBUS
3	INT3-	ON	GINT2- of GBUS
4	INT4-	ON	GINT3- of GBUS

5.8. 7SEG-LED, XXX-LED

The LEDs are used to indicate statuses, as listed below. The four 7-segment LEDs are used by the monitor at startup. After that, they can be used for any user application.



Name	Description
POWER	Lights when power is supplied to the port.
SRAM	Lights during access to the PB-SDRAM space.
DRAM	Lights during access to the SDARM space.
LOCAL	Lights during access to the LOCAL space.
GBUS	Lights during access to the GBUS space.

Board LED Status

5.9. CLOCK SOCKET (OSC1)

An oscillator for generating the clock signal to be supplied to the CPU is mounted in the OSC1 socket. OSC1 is converted to the 3.3-V level, and is connected to the CPUCLK pin of the CPU. Accepts DIP 8-pin (half-type) oscillators.

When you have to cut an oscillator pin for convenience, be careful not to cut it too short, or otherwise the frame (housing) of the oscillator may touch a pin in the socket, resulting in a short-circuit occurring.

5.10. ROM SOCKETS

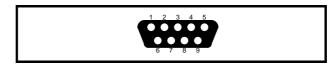
The RTE-VR5432-CB has ROM sockets to hold 40-pin ROM chips to provide standard 128 Kbytes (64K \times 16 bits). When the ROM chips used here are to be replaced, their type should be 27C1024, 27C2048, or 27C4096, and the access time should be 120 ns or less. The SW3 switch must be set again when the type of ROM is changed or a ROM emulator is connected. (See **5.5 SWITCH3 (SW3)**)

5.11. SERIAL CONNECTOR (JSIO1, JSIO2)

The JSIO1 and JSIO2 connectors are used for the RS-232C interface that is controlled by the serial controller (TL16C550CPT) on the board.

JSIO1 and JSIO2 are 9-pin D-SUB RS-232C connectors (male) like that commonly used on the PC/AT. All signals on both of these connectors are converted to the RS-232C level. The figure and table below indicate the pin and signal arrangement of these connectors.

For the signals to be connected to the host, the table indicates two modes of wiring on the host: one for a 9-pin D-SUB connector, and the other for a 25-pin D-SUB connector. (Regular cross-cable wiring is used for these connections.)



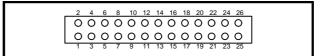
			ut/ Connector pin number on the host sid		
JSIOx pin	Signal name	output	D-SUB9	D-SUB25	
1	DCD	Input			
2	RxD(RD)	Input	3	2	
3	TxD(SD)	Output	2	3	
4	DTR(DR)	Output	1, 6	6, 8	
5	GND		5	7	
6	DSR(ER)	Input	4	20	
7	RTS(RS)	Output	8	5	
8	CTS(CS)	Input	7	4	
9	RI	Input			

Pin Arrangement of JSIO1 and JSIO2

Connector Signals of JSIO1 and JSIO2

5.12. PARALLEL CONNECTOR (JPRT)

The JPRT connector is a printer connector controlled by the serial/parallel controller (TL16PIR552). Since the connector consists of 26 header pins, a conversion cable is required to use this connector as a normal printer connector. The numbers of the connector pins and their functions are described below.



JPRT pin	Signal name	Input/output	Remark
1	STB-	Output	10-KΩ pull-up
2	AUTO_FD-	Output	10-KΩ pull-up
3	D0	Output	10-KΩ pull-up
4	ERROR-	Input	10-KΩ pull-up
5	D1	Output	10-KΩ pull-up
6	INIT-	Output	10-KΩ pull-up
7	D2	Output	10-KΩ pull-up
8	SELECT_IN-	Output	10-KΩ pull-up
9	D3	Output	10-KΩ pull-up
11	D4	Output	10-KΩ pull-up
13	D5	Output	10-KΩ pull-up
15	D6	Output	10-KΩ pull-up
17	D7	Output	10-KΩ pull-up
19	ACK-	Input	10-KΩ pull-up
21	BUSY	Input	10-KΩ pull-up
23	PE	Input	10-KΩ pull-up
25	SELECT	Input	10-KΩ pull-up
26	NC		Not used
10,12,14,16, 18,20,22,24	GND		

JPRT Pin Arrangement

JPRT Connector Signal Table

5.13. ROM EMULATOR TEST PIN (JROM-EML)

JROM-EML is a test pin used when a ROM emulator is connected. The following control signals can be input.

Signal name	Input/ output	Function
RESET- (1)	Input	All the ports are reset by inputting a low level. Connect reset request signals from the ROM emulator. Pulled up with $1-K\Omega$ resistor.
NMI- (2)	Input	NMI is input to the CPU by inputting a low level. Connect NMI request signals from the ROM emulator. Pulled up with $1-K\Omega$ resistor.
GND(3)		GND. Connect to GND of ROM emulator.

JROM_EM Pin Functions

5.14. ICE CONNECTOR (JDCU)

This connector is used to connect an in-circuit emulator (ICE). It enables connection of an RTE-TP type ICE. The following signals are connected.

Pin No.	Signal name	Pin No.	Signal name
A1	TRCCLK	B1	GND
A2	TRCDATA0	B2	GND
A3	TRCDATA1	B3	GND
A4	TRCDATA2	B4	GND
A5	TRCDATA3	B5	GND
A6	TRCEND	B6	GND
A7	DDI	B7	GND
A8	DCK	B8	GND
A9	DMS	B9	GND
A10	DDO	B10	GND
A11	/DRST	B11	NC.
A12	/BKTGIO	B12	NC.
A13	NC.	B13	+3.3V

JDCU2 Connector Signals

Board-side connector: KEL 8830E-026-170S

5.15. JGBUS CONNECTOR (JGBUS)

This is a 32-bit data width bus connector for expansion purposes. For details, see **10 SPECIFIC GBUS SPECIFICATIONS** and **14 APPENDIX C GBUS COMMON SPECIFICATIONS**.

5.16. CPU CONNECTORS (JCP1, 2)

The CPU connector signals are directly linked to the VR5432. Since these signals are used in the board, caution is required when pulling out signals from JCPU.

JCPU pin No.	Signal name	JCPU pin No.	Signal name
1	+5V	2	GND
3	SYSAD31	4	SYSAD30
5	SYSAD29	6	SYSAD28
7	SYSAD27	8	SYSAD26
9	SYSAD25	10	SYSAD24
11	+5V	12	GND
13	SYSAD23	14	SYSAD22
15	SYSAD21	16	SYSAD20
17	SYSAD19	18	SYSAD18
19	SYSAD17	20	SYSAD16
21	+3.3V	22	GND
23	SYSAD15	24	SYSAD14
25	SYSAD13	26	SYSAD12
27	SYSAD11	28	SYSAD10
29	SYSAD9	30	SYSAD8
31	+3.3V	32	GND
33	SYSAD7	34	SYSAD6
35	SYSAD5	36	SYSAD4
37	SYSAD3	38	SYSAD2
39	SYSAD1	40	SYSAD0
41	+2.7V	42	GND
43	/NMI	44	/INT0
45	/INT1	46	/INT2
47	/INT3	48	/INT4
49	+2.7V	50	GND
51	no use	52	no use

JCPU1 Connector

JCPU pin No.	Signal name	JCPU pin No.	Signal name
1	+5V	2	GND
3	SYSCMD4	4	SYSCMD3
5	SYSCMD2	6	SYSCMD1
7	SYSCMD0	8	no use
9	no use	10	no use
11	+5V	12	GND
13	/EVALID	14	/SYSRESET
15	/EREQ	16	/PMASTER
17	/EOK	18	/PVALID
19	/PREQ	20	no use
21	+3.3V	22	GND
23	SYSADC3	24	SYSAD2
25	SYSADC1	26	SYSADC0
27	SYSCLK2	28	no use
29	+3.3V	30	GND
31	JTDO	32	JTDI
33	JTCK	34	JTMS
35	TRISTATE	36	/COLDRESET
37	ENDIAN	38	no use
39	+2.7V	40	GND
41	DIVMODE0	42	DIVMODE1
43	TRCEND	44	TRCDATA3
45	TRCDATA2	46	TRCDATA1
47	TRCDATA0	48	/BKTGIO
49	+2.7V	50	TRCCLK
51	no use	52	no use

JCPU2

Connector: Hirose, board side: FX2-52P-1.27SV, other side: FX2-52S-1.27SV

6. CONNECTION WITH THE HOST PC

6.1. RS-232C CONNECTION

RS-232C connect the host machine using the monitor ROM by means of the following procedure:

- <1> Get an optional RS-232C cable and a power supply.
- <2> Set and check the setting of the switches on the board. Specify a baud rate by using SW1 (see 11.1.2 SW1 Setting and 12.1.1 SW1 Setting).
- <3> Connect the JSIO1 connector and host machine with the RS-232C cable, and supply power to the JPOWER connector. Confirm that the POWER-LED on the board lights and that the 7segment LED indicating that the monitor has started lights.

If the LED does not light, turn off the power immediately, and check the connection.

<4> Start the debugger on the host machine, and connect it via the RS-232C interface. If an error occurs, confirm the connection of the serial cable and the setting of the switches (especially, baud rate). For the method and procedure of starting the debugger, see the debugger manual.

Place the board on an insulating material. If a conductive material touches the board while power is supplied to the board, the board may malfunction.

7. HARDWARE REFERENCES

This chapter describes the hardware of the RTE-VR5432-CB.

7.1. RESET

Resets are effected by the causes listed below. They are handled as cold reset of the CPU, and result in system reset of the control circuits on the board.

- Power-on reset: Triggered at power-on of the board.
- Reset switch: Triggered by Reset switch (SW RST) provided on the board.
- GBUS reset: Reset request from the JGBUS connector.
- JROM_reset: Input from Pin No. 1 (RESET-) of the JROM_EML connector. (See 5.13 ROM EMULATOR TEST PIN (JROM-EML).)
- DCU reset: Reset request from the in-circuit emulator. (See 5.13 ROM EMULATOR TEST PIN (JROM-EML).)

7.2. INTERRUPTS

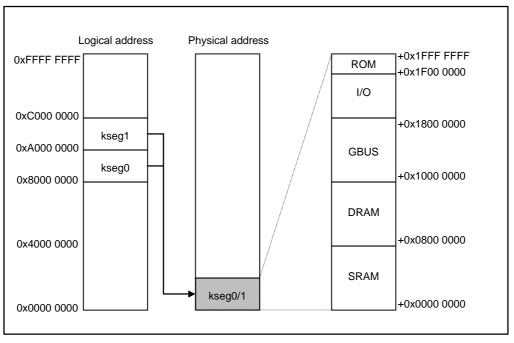
Interrupts sources from CPU external are as follows.

Interrupt	Source	Reference
NMI-	JROM_EML (NMI-)	5.13
INT0-	PIC INTOM	7.4.9
INT1-	PIC INT1M	7.4.9
INT2-	GBUS_INT1-	
INT3-	GBUS_INT2-	
INT4-	GBUS_INT3-	

Memo For the programming method using interrupts in the monitor environment, see **13 APPENDIX C INTERRUPT PROGRAMMING**.

7.3. ADDRESS MAP

The board's address allocation is as follows.



Address Map

When a program is executed using a remote monitor, this is done using the kernel space 8000-0000H to BFFF-FFFFH without using TLB mapping. The physical address is determined by adding 8000-0000H when using a cache, or adding A000-0000H when not using a cache.

7.3.1. SRAM Space (0000-0000H to 07FF-FFFFH)

Two PB-SRAM devices, each consisting of 32 Kbytes \times 32 bits, are provided as SRAM. The total capacity is therefore 256 Kbytes. Access with 0 waits is possible up to the maximum bus clock, but wait emulation inserting 0 to 3 clocks of wait is also possible. (See **7.4.1 SRAM Controller (SRAMC B800-6000[Read/Write])**).

Since the high-order bits of the address lines are not decoded, an image appears every 256 Kbytes. Access can be performed to both cached and non-cached space.

7.3.2. DRAM Space (0800-0000H to 0FFF-FFFH)

Eight SDRAM devices, each consist of 4 Mbytes \times 4 bits \times 4 banks are provided as DRAM. The total capacity is therefore 64 Mbytes. SDRAM settings must be performed prior to SRAM use. (See **7.4.2 DRAM Controller (DRAMC B800-5000[Read/Write])**). Since the high-order bits of the address lines are not decoded, an image appears every 64 Mbytes. Access can be performed to both cached and non-cached space.

7.3.3. GBUS Space (1000-0000H to 17FF-FFFH)

Regarding the GBUS area, the access space is mapped to GBUS. For details, see **10 SPECIFIC GBUS SPECIFICATIONS**. Access to both cached and non-cached space is possible from the board, but allocate use according to the resources of the access destination.

7.3.4. I/O Space (1800-0000H to 1EFF-FFFFH)

This space (memory mapped I/O) is allocated by the I/O device for controlling the functions of the board. For details on the I/O map, etc., see **7.4 I/O DETAILS**. Access is performed to non-cached space.

7.3.5. ROM Space (1F00-0000H to 1FFF-FFFFH)

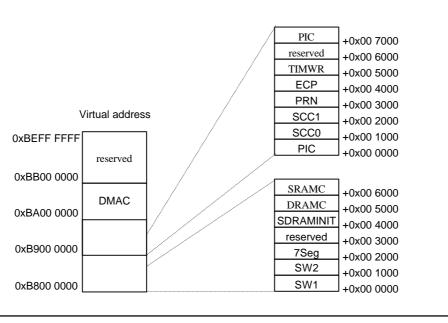
Regarding the ROM space, either 128 Kbytes (64 K words \times 16 bits), 256 Kbytes (128 K words \times 16 bits), or 512 Kbytes (256 K words \times 16 bits) of UV-EPROM with an access time of 120 ns or less can be mounted. The type of ROM and the usage method are set with SW3. (See **5.5 SWITCH 3 (SW3)**.) Since the high-order bits of the address lines are not decoded, an image appears for each ROM capacity.

The number of ROM waits varies depending on the SW2-3 (BCLK_LOW) settings, but an access time of 120 ns or more is secured for the maximum frequency.

Access can be performed from both cached and non-cached spaces.

7.4. I/O DETAILS

A memory access controller, DUART/LPT, timer, and interrupt controller are among the I/O devices mapped in the memory space. The various I/O allocations are as follows.



I/O Map

Since kernel non-cached space access is assumed for these I/Os, logical addresses are used in the following explanation.

7.4.1. SRAM Controller (SRAMC B800-6000[Read/Write])

The SWAIT register performs wait control for the SRAM space. 0 to 3 waits can be set for the read cycle using this register. The register allocation is as follows.

	Deviator	Data bus			
Logical address	Register	D3	D2	D1	D0
B800 -6000H	SRAMC SWAIT	0	0	SWAIT1	SWAIT0

SWAIT[1..0]: Sets the number of waits during SRAM read.

SW	AIT	Number of CDAM read write		
1	0	Number of SRAM read waits		
0	0	0	Recommended value	
0	1	1		
1	0	2		
1	1	3	(Reset value)	

7.4.2. DRAM Controller (DRAMC B800-5000[Read/Write])

DRAMC sets the access conditions. The register allocation is as follows.

		Data bus			
Logical address	Register	D3	D2	D1	D0
B800 -5000H	DRAMC RCD	0	0	RCD1	RCD0
-5010H	DRAMC RP	0	0	RP1	RP0
-5020H	DRAMC RC	0	RC2	RC1	RC0
-5030H	DRAMC RRC	0	RRC2	RRC1	RRC0
-5040H	DRAMC RAS	0	RAS2	RAS1	RAS0
-5050H	DRAMC LAT	0	0	LAT1	LAT0
-5060H	DRAMC RSC	0	0	RSC1	RSC0
-5070H	DRAMC AP	0	0	0	AP

RCD[1..0]: Sets SDRAM parameter tRCD (Delay ACT to read/write).

R	CD	4D.C.D.	Demer	
1	0	tRCD	Remark	
0	0			
0	1			
1	0	2 SYSCLK	Recommended value	
1	1	3 SYSCLK	(Reset value)	

Memo Use the recommended value. The operation is not guaranteed if a value other than the recommended value is used.

RP[1..0]: Sets SDRAM parameter tRP (PRE to ACT/REF).

R	P		Demed
1	0	tRP	Remark
0	0		
0	1	-	
1	0	2 SYSCLK	Recommended value
1	1	3 SYSCLK	(Reset value)

Memo Use the recommended value. The operation is not guaranteed if a value other than the recommended value is used.

	RC		120	Deved
2	1	0	tRC	Remark
0	0	0		
0	0	1		
0	1	0		
0	1	1		
1	0	0		
1	0	1	5 SYSCLK	Recommended value
1	1	0	6 SYSCLK	
1	1	1	7 SYSCLK	(Reset value)

RC[2..0]: Sets SDRAM parameter tRC (ACT to REF/ACT).

Memo Use the recommended value. The operation is not guaranteed if a value other than the recommended value is used.

RRC[2..0]: Sets SDRAM parameter tRRC (REF to REF/ACT).

	RRC		1000	Demerk
2	1	0	tRRC	Remark
0	0	0		
0	0	1		
0	1	0		
0	1	1		
1	0	0		
1	0	1		
1	1	0	6 SYSCLK	Recommended value
1	1	1	7 SYSCLK	(Reset value)

Memo Use the recommended value. The operation is not guaranteed if a value other than the recommended value is used.

RAS[2..0]: Sets SDRAM parameter tRC (ACT to PRE).

	RAS		4D A C	Demorte
2	1	0	tRAS	Remark
0	0	0		
0	0	1		
0	1	0		
0	1	1		
1	0	0	4SYSCLK	Recommended value
1	0	1		
1	1	0		
1	1	1	7 SYSCLK	(Reset value)

Memo Use the recommended value. The operation is not guaranteed if a value other than the recommended value is used.

LAT[1..0]: Sets SDRAM parameter tLAT (/CAS latency).

LA	٩T	4 AT	Demort
1	0	tLAT	Remark
0	0		
0	1		
1	0	2 SYSCLK	Recommended value
1	1	3 SYSCLK	(Reset value)

Memo Use the recommended value. The operation is not guaranteed if a value other than the recommended value is used.

RSC[1..0]: Sets SDRAM parameter tRSC (Mode Register Set Cycle Time).

RS	SC	tRSC	Remark
1	0	ikse	Remark
0	0		
0	1	-	
1	0	2 SYSCLK	Recommended value
1	1	3 SYSCLK	(Reset value)

Memo Use the recommended value. The operation is not guaranteed if a value other than the recommended value is used.

AP: Sets whether to use the SDRAM automatic precharge function.

AP	Automatic precharge	Remark
0	Use	
1	Don't use	Reset value

7.4.3. DRAM Initialization Port (DRAM_INIT B800-4000H[Write Only])

SDRAM is initialized based on the DRAMC setting value. Data is don't care. The Mode Register Set command of SDRAM is issued when output is performed.

This port is used to write the parameters set for the ports to SDRAM. After setting all the parameters to the ports, output them to this port as the last step.

7.4.4. SW1 Read Port (SW1 B800-0000H [Read Only])

This port is used to read the status of SW1. The table below indicates the data format.

Dhuming La dalar an	Data bus							Octilian	
Physical address	D7	D6	D5	D4	D3	D2	D1	D0	Setting
B800000H	SW1	SW1	SW1	SW1	SW1	SW1	SW1	SW1	0 = ON
input	-8	-7	-6	-5	-4	-3	-2	-1	1 = OFF

SW1-1 corresponds to switch 1 of SW1, while SW1-8 corresponds to switch 8 of SW1. When a bit of the corresponding switch is set to ON, 0 is read. When it is set to OFF, 1 is read. SW1 is used to set the operation of the monitor. For how to set this switch, see **11.1.2 SW1 Setting** and **12.1.1 SW1 Setting**.

7.4.5. SW2 Read Port (SW2 B800-1000H [Read Only])

This port is used to read the status of SW2. The data format of this port is shown in the table below.

Dhuaisal addusas	Data bus								Catting	
Physical address	D7	D6	D5	D4	D3	D2	D1	D0	Setting	
B801000H	SW2	SW2	SW2	SW2	SW2	SW2	SW2	SW2	0 = ON	
input	-8	-7	-6	-5	-4	-3	-2	-1	1 = OFF	

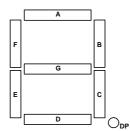
SW2-1 corresponds to bit 1 of SW2, and SW2-8 corresponds to bit 8 of SW2. When a bit of the corresponding switch is set to ON, 0 is read; when it is set to OFF, 1 is read. SW2 is used to switch the hardware operation. For the function of each switch, see **5.4 SWITCH2 (SW2)**.

7.4.6. 7-Segment LED Display Data Output Port (7SEG-LED B800-2000 [Write Only])

This port sets the data to be displayed on the four 7-segment LED. The table below indicates the data format. When a bit is set to 0, the corresponding segment is turned on.

La siant a data an		Data							
Logical address	D731	D630	D529	D428	D327	D226	D125	D024	Setting
B800-2000H	LED1								
output	-DP	-G	-F	-E	-D	-C	-B	-A	
B800-2001H	LED2								
output	-DP	-G	-F	-E	-D	-C	-B	-A	0 = Turned on
B800-2002H	LED3	1 = Turned off							
output	-DP	-G	-F	-E	-D	-C	-B	-A	
B800-2003H	LED4								
output	-DP	-G	-F	-E	-D	-C	-B	-A	

The figure below illustrates the correspondence between the bits and the segments of the 7-segment LED.



7.4.7. Serial/parallel I/O (SCC0/1 LPT B900-1000 to B900-4000[Read/Write])

The TL16PIR552 (dual UART with 1284 parallel port) made by Texas Instruments is used as the UART/printer. The TL16PIR552 provides two UART channels and an IEEE1284-compliant bidirectional printer port (1 channel). The UART send/receive block features a 16-character FIFO buffer, and a function to automatically control the RTS/CTS flow is provided, which reduces overrun errors with a minimum of interrupts.

The TL16PIR552 registers are allocated as indicated in the table. For the functions of the registers, see the TL16PIR552 manual. (The TL16PIR552 manual can be obtained in the TI&ME corner in the homepage of Texas Instruments (http://www.ti.com/).

Address	Function	Read	Write
B900-1000	UART-CH#0	RBR/DLL	THR/DLL
B900-1010		IER/DLM	IER/DLM
B900-1020		IIR	FCR
B900-1030		LCR	LCR
B900-1040		MCR	MCR
B900-1050		LSR	LSR
B900-1060		MSR	MSR
B900-1070		SCR	SCR
B900-2000	UART-CH#1	RBR/DLL	THR/DLL
B900-2010		IER/DLM	IER/DLM
B900-2020		IIR	FCR
B900-2030		LCR	LCR
B900-2040		MCR	MCR
B900-2050		LSR	LSR
B900-2060		MSR	MSR
B900-2070		SCR	SCR
B900-3000	PRINTER(PPCS-)	DATA	DATA/ECPAFIFO
B900-3010		DSR	
B900-3020		DCR	DCR
B900-3030		EPPADDR	EPPADDR
B900-3040 to B900-3070		EPPDATA	EPPDATA
B900-4000	PRINTER(ECPCS-)	PPDATAFIFO/	PPDATAFIFO/
		TESTFIFO/CNFGA	TESTFIFO
B900-4010		CNFGB	
B900-4020		ECR	ECR

TL16PIR552 Register Allocation

A 16-MHz clock is connected to the XIN input of the TL16PIR552.

The UART-CH#0, UART-CH#1, and PRINTER interrupts can be connected to CPU interrupts via PIC. UART-CH#0, UART-CH#1, and PRINTER are connected to the JSIO1 connector, JSIO2 connector, and JPRT on the rear panel, respectively. Moreover, UART-CH#0 is used when using a debugger for serial transmission, and INT0 is used via PIC as the interrupt at this time. The TL16PIR552 is reset by system reset.

Caution Do not change the contents of UART-CH#0 when using the monitor.

7.4.8. Timer (Timer B900-5000[Read/Write])

NEC's **m**PD71054 is used as the timer. The **m**PD71054 is compatible with Intel's i8254, and is provided with three timer counters. Various types of control can be performed using these timers. The **m**PD71054 registers are allocated as shown in the table below.

Logical address	Register	Complement
B900-5000	PCNT0	Timer 0
B900-5010	PCNT1	Timer 1
B900-5020	PCNT2	Timer 2
B900-5030	PCNTL	Control

For the functions of the registers, see the manual of the *m*PD71054. The timer is used as follows.

Timer	Clock	Mode	Application	
0	2MHz	2	Timer interrupt 0	Used for monitor
1	2MHz	2	Timer interrupt 1	Can be used by user
2	2MHz	2	DRAM refresh	

Caution Do not change the contents of timer 0 when using the monitor.

7.4.9. Interrupt Controller (PIC B900-0000[Read/Write])

PIC performs interrupt control. The register allocation is as follows.

	Register		Data bus							
Logical address			D7	D6	D5	D4	D3	D2	D1	D0
B900-0000	PIC	INTOM	IM07	IM06	IM05	IM04	IM03	IM02	IM01	IM00
B900-0010	PIC	INT1M	IM17	IM16	IM15	IM14	IM13	IM12	IM11	IM10
B900-0020	PIC	INTR	IR7	IR6	IR5	IR4	IR3	IR2	IR1	IR0
B900-0030	PIC	INTEN	0	0	0	0	0	0	INT1	INT0
									EN	EN

The INTOM and INT1M registers mask interrupts input to INT0 and INT1, respectively. They are enabled when the IM0x and IM1x bits are "1," and when several bits have been selected, interrupts become active through ORing.

The INTR register is the interrupt status, and "1" is read when there is an interrupt request, regardless of the mask status. Write "1" to the bit corresponding to this register to clear an edge interrupt request.

The interrupt sources allocated to the IM0[0..7], IM1[0..7], and IR[0..7] bits are as follows.

IM0,IM1,IR	Interrupt source	Request level
0	Timer 0 (Mode 2)	Edge (rising)
1	Serial 0	Level (high)
2	GBUS-INT0-	Level (low)
3	BUS ERROR	Level (low)
4	Timer 1 (Mode 2)	Edge (rising)
5	Serial 1	Level (high)
6	Parallel (printer)	Edge (rising)
7	DMAC INTREQ-	Level (low)

The INTEN register enables/disables interrupts to INT0, INT1.

INTEN0: Controls INT0. INT0 can be disabled by hardware with this bit. At this time, the status of the INT0 pin changes to high level.

INTEN0	INTO	
0	Disable	(Reset value)
1	Enable	

INTEN1: Controls INT1. INT0 can be disabled by hardware with this bit. At this time, the status of the INT1 pin changes to high level.

INTEN1	INT1	
0	Disable	(Reset value)
1	Enable	

Caution Do not change INT0-related contents when using the monitor.

7.4.10. DMA Controller

This controller is used to perform DMA transfer between GBUS resources in response to DMA requests from GBUS. A total of 4 DMA controller channels are provided.

DMA transfer is normally performed in 2 cycles (read cycle and write cycle). Burst cycles are not supported.

7.4.10.1. DMA channel 0 control port (DMACNT0 BA00-0000[Read/Write])

7.4.10.2. DMA channel 1 control port (DMACNT1 BA00-0080[Read/Write])

7.4.10.3. DMA channel 2 control port (DMACNT2 BA00-0100[Read/Write])

7.4.10.4. DMA channel 3 control port (DMACNT3 BA00-0180[Read/Write])

Bit	Signal name	RST	Function
0	DMA_EN ^{*1}	0	0: Stop DMA
			1: Execute DMA
1	TC ^{*2}	0	0: DMA transfer not completed
			1: DMA transfer completed
2	DMA_SINGLE ^{*3}	х	0: Continuously use GBUS.
			1: Release GBUS once after every transfer
3	SOFT_DREQ ^{*4}	х	0: Perform DMA transfer according to the hardware DMA request line.
	*=		1: Perform DMA transfer even if the hardware DMA request line is inactive.
4	DATA_SIZE[0] *5	х	Set size of data to be transferred with DATA_SIZE[1:0].
5	DATA_SIZE[1] ^{*5}	х	
6	Not used	х	
7	Not used	х	
8	DST_CD[0] *6	х	Set transfer destination address increase/decrease with DST_CD[1:0].
9	DST_CD[1] ^{*6}	х	
10	Not used	х	
11	Not used	х	
12	SRC_CD[0] ^{*6}	х	Set transfer destination address increase/decrease with SRC_CD[1:0].
13	SRC_CD[1] ^{*6}	х	
14	Not used	х	
15	Not used	х	
16	DST_CS[0] ^{*7}	х	Specify the GBUS chip select space of the transfer destination address with
17	DST_CS[1] *7	х	DST_CS[1:0].
18	DST_CS[2] ^{*7}	х	
19	Not used	х	
20	SRC_CS[0] *7	х	Specify the GBUS chip select space of the transfer destination address with
21	SRC_CS[1] ^{*7}	x	SRC_CS[1:0].
22	SRC_CS[2] ^{*7}	х	
23	Not used	x	
24	Not used	х	
25	Not used	х	
26	Not used	х	
27	Not used	х	
28	Not used	х	
29	Not used	х	
30	Not used	х	
31	Not used	х	

<<Cautions>>

 Set "1" to DMA_EN after completing the settings of the other bits. Do not change DMA_EN from "0" to "1" while manipulating other bits.

Do not overwrite other bits in the DMA controller when DMA_EN is "1." The operation is not guaranteed if other bits are overwritten at this time.

- TC becomes "1" after the number of bytes set in the Byte Count register has been transferred. Write "1" to this bit to clear TC.
 Prior to clearing TC, write "0" to DMA_EN. If TC is cleared while DMA_EN is "1," DMA starts again
- the instant it is cleared.
 When DMA_SINGLE is set to "1," the DMA controller gives up the GBUS mastership every time one DMA transfer is completed, enabling the CPU to use the GBUS. When DMA_SINGLE is set to "0," DMA is continued while the DMA controller retains the GBUS mastership, and the CPU cannot acquire the GBUS mastership until DMA transfer ends. For details, see 7.4.10.19 Single transfer and non-single transfer.
- 4. When SOFT_DREQ is set to "1," DMA transfer is performed without the need for hardware DMA requests. However, even if SOFT_DREQ is "1," the DMAAK signal of the GBUS becomes active during the DMA cycle.
- 5. The DATA_SIZE[1:0] settings are as follows.
 - [0,0]: 8-bit transfer
 - [0,1]: 16-bit transfer
 - [1,0]: 32-bit transfer
 - [1,1]: Setting prohibited
- 6. The DST_CD[1:0] and SRC_CD[1:0] settings are as follows. The transfer address increment/decrement unit is determined by the DATA_SIZE[1:0] setting.
 - [0,0]: Fixed
 - [0,1]: Increment
 - [1,0]: Decrement
 - [1,1]: Setting prohibited
- 7. The DST_CS[2:0] and SRC_CS[2:0] settings are as follows.
 - [0,0,0]: GCS0 space
 - [0,0,1]: GCS1 space
 - [0,1,0]: GCS2 space
 - [0,1,1]: GCS3 space
 - [1,0,0]: GCS4 space
 - [1,0,1]: GCS5 space
 - [1,1,0]: GCS6 space

7.4.10.5. DMA channel 0 transfer origin address port (DMASRCADDR0 BA00-0010[Read/Write]) 7.4.10.6. DMA channel 1 transfer origin address port (DMASRCADDR1 BA00-0090[Read/Write]) 7.4.10.7. DMA channel 2 transfer origin address port (DMASRCADDR2 BA00-0110[Read/Write]) 7.4.10.8. DMA channel 3 transfer origin address port (DMASRCADDR3 BA00-0190[Read/Write])

These ports are used to set DMA transfer origin addresses. 24 bits from A0 to A23 are effective for the address. Transfer addresses must be aligned to the data size specified in DATA_SIZE[1:0] set to the DMA control port of each channel. The operation in case the set addresses are not aligned is undefined. The contents of the address to be used for DMA transfer can be read from these ports during DMA transfer or upon DMA transfer end.

7.4.10.9. DMA channel 0 transfer destination address port (DMADSTADDR0 BA00-0020[Read/Write]) 7.4.10.10. DMA channel 1 transfer destination address port (DMADSTADDR1 BA00-00A0[Read/Write]) 7.4.10.11. DMA channel 2 transfer destination address port (DMADSTADDR2 BA00-0120[Read/Write]) 7.4.10.12. DMA channel 3 transfer destination address port (DMADSTADDR3 BA00-01A0[Read/Write])

These ports are used to set DMA transfer destination addresses. 24 bits from A0 to A23 are effective for the address. Transfer addresses must be aligned to the data size specified in DATA_SIZE[1:0] set to the DMA control port of each channel. The operation in case the set addresses are not aligned is undefined. The contents of the address to be used for DMA transfer can be read from these ports during DMA transfer or upon DMA transfer end.

7.4.10.13. DMA channel 0 byte count port (DMABYTECNT0 BA00-0030[Read/Write]) 7.4.10.14. DMA channel 1 byte count port (DMABYTECNT1 BA00-00B0[Read/Write]) 7.4.10.15. DMA channel 2 byte count port (DMABYTECNT2 BA00-0130[Read/Write]) 7.4.10.16. DMA channel 3 byte count port (DMABYTECNT3 BA00-01B0[Read/Write])

These ports are used to set the **number of bytes to be DMA transferred - 1**. 24 bits of data from Bit 0 to Bit 24 are effective. The DMA controller decrements the contents of this port by 1, 2, or 4 according to the data size specified in DATA_SIZE[1:0] set for the DMA control port of each channel, every time one DMA transfer ends. DMA ends when result carry for this decrementing operation occurs (TC becomes "1.")

The current byte counter value can be read during DMA transfer or upon DMA transfer end.

Bit	Signal name	RST	Function
0	INT_EN[0]	0	0: Don't request interrupt when TC bit of channel 0 is "1."0: Request interrupt when TC bit of channel 0 is "1."
1	INT_EN[1]	0	0: Don't request interrupt when TC bit of channel 1 is "1." 0: Request interrupt when TC bit of channel 1 is "1."
2	INT_EN[3]	0	0: Don't request interrupt when TC bit of channel 2 is "1."0: Request interrupt when TC bit of channel 2 is "1."
3	INT_EN[4]	0	0: Don't request interrupt when TC bit of channel 3 is "1." 0: Request interrupt when TC bit of channel 3 is "1."
4	TC[0] ^{*1}	0	Read contents of TC bit of channel 0.
5	TC[1] ^{*1}	0	Read contents of TC bit of channel 1.
6	TC[2] ^{*1}	0	Read contents of TC bit of channel 2.
7	TC[3] ¹	0	Read contents of TC bit of channel 3.

7.4.10.17. DMA interrupt control port (DMAINTCNT BA00-0200[Read/Write])

<<Caution>>

For TC[3:0], the contents of Bit 1 of the DMA control port can be read as is. This bit enables judgment of which channel has issued an interrupt request.

TC[3:0] of this port is read-only, and when TC is cleared, TC of the control port of each channel must be manipulated.

7.4.10.18. Priority

Channel 0 has the highest priority, and channel 3 has the lowest priority. If several DMA requests are contending, which channel DMA transfer is to be performed is judged based on the status of the DMA request immediately before the start of the bus cycle following acquisition of the GBUS mastership.

7.4.10.19. Single transfer and non-single transfer

The setting made in DMA_SINGLE of the DMA control port determines whether the GBUS mastership is relinquished following the end of DMA transfer of 1 cycle for each channel. The setting made in DMA_SINGLE of each channel determines the status following the DMA transfer cycle of the corresponding channel.

When DMA_SINGLE is set to "1," the DMA controller relinquishes the GBUS mastership every time one DMA transfer has ended, giving the CPU the opportunity to use the GBUS. If this is followed by an active DMA request, the DMA controller again requests mastership of the GBUS.

When DMA_SINGLE of the DMA control port is set to "0," the DMA controller does not relinquish the GBUS mastership in the case of an active DMA request (or if SOFT_DREQ is "1") even if transfer ends, and DMA transfer is continued. However, since arbitration of priority between channels is performed, DMA transfer is not necessarily performed for the same channel.

7.4.10.20. DMA request sample timing during non-single transfer

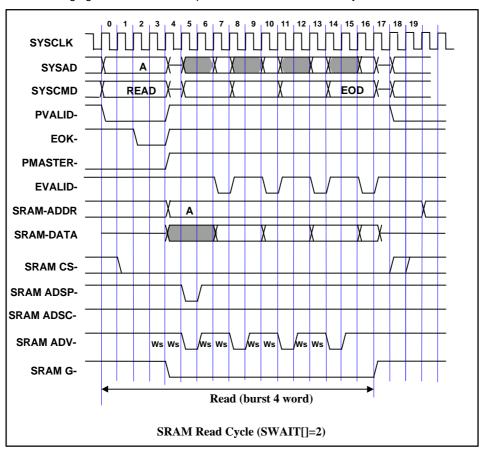
Whether or not to perform the DMA cycle during non-single transfer depends on the DMA request status at the timing (GREADY = Low, GWAITI = High) when the write cycle to the transfer destination becomes ready. If this timing corresponds to when a DMA request is active, the DMA controller keeps the GBUS mastership and DMA transfer is continued.

8. BUS CYCLE TIMING

In the RTE-VR5432-CB, access is performed from the SYSAD via the bridge for SRAM, DRAM, ROM, and I/O devices. The basic control timing for each access cycle is described below.

8.1. SRAM ACCESS

The number of wait cycles for SDRAM read access is set with the SRAMC-SWAIT register. The selection range is 0 to 3 wait cycles. (See **7.4.1 SRAM Controller (SRAMC B800-6000[Read/Write]**.) The following figure shows an example of burst read with 2 wait cycles set.



The status is described below following the clock number.

0 to 1: The CPU's external read cycle starts. Normally, EOK- is inactive.

2 to 3: The SRAM read cycle is determined and EOK- becomes active.

3 to 4: The number of wait cycles set with SWAIT (in this example, 2) is inserted.

5: A read command is issued to PBSRAM.

7: Data is output from PBSRAM. EVALID- is returned accordingly.

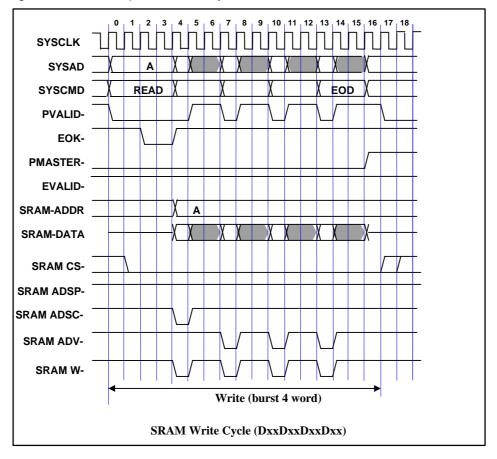
8 to 16: Cycles are repeated until the last data (EOD).

(6 to 8): The number of wait cycles set with SWAIT (in this example, 2) is inserted.

SRAM ADV- is made active, and the internal address of PBSRAM is incremented.

Note In the case of 8-word burst data, the SRAM ADSP signal is made active at clock 16, an address is provided from external, and burst processing continues.

The SRAM write cycle follows the CPU's output data rate (DDDD or DxxDxxDxxDxx). In the case of SRAM, EOK- is returned 2 clocks after address determination and the cycle is started. The following figure shows an example of the burst cycle of data rate DxxDxxDxxDxx.



The status is described below following the clock number.

0 to 1: The CPU's external write cycle starts. Normally, EOK- is inactive.

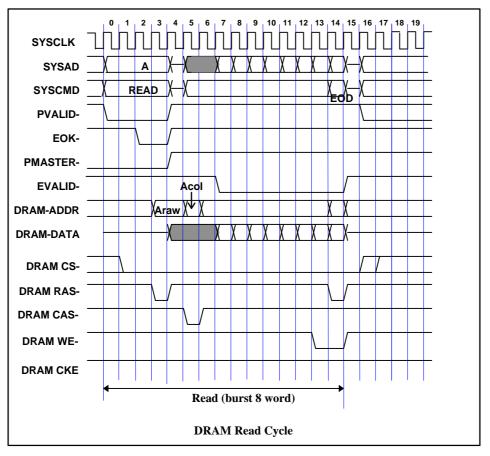
2 to 3: The SRAM write cycle is determined and EOK- becomes active.

4: The first data output is performed. At this time, the data is directly latched to PBSRAM and the write operation starts. The address is latched beforehand and provided simultaneously at this time.

5 to 13: The write operation is repeated. The address counter in PBSRAM is incremented for the second and subsequent write cycles. The timing for SRAM ADV- and SRAM W is adjusted to the data rate. (When the data rate is DDDD, the active status occurs continuously.)

8.2 DRAM ACCESS

DRAM controller settings are required for DRAM. (See **7.4.2 DRAM Controller (DRAMC B800-5000[Read/Write]**.) In the following example, all the settings correspond to the recommended values. The DRAM read cycle when PAGE = 0 (auto precharge ON) is shown below. However, this corresponds to the start of the cycle, if refresh and precharge do not overlap. If they overlap, the end of these cycles is waited for.



The status is described below following the clock number.

0 to 1: The CPU's external read cycle starts. Normally, EOK- is inactive.

2 to 3: Access to DRAM is determined, EOK- becomes active, and at clock 3, an active command is issued for SDRAM. The row address is given to DRAM ADDR at this time.

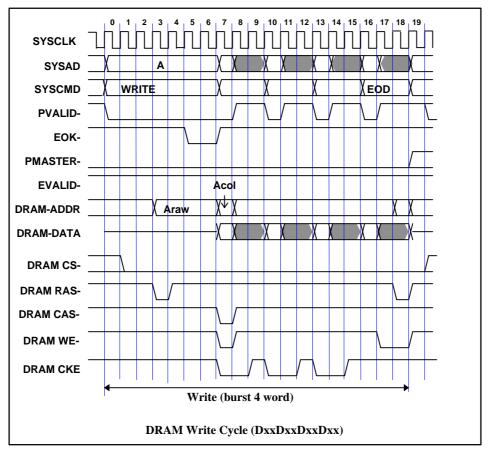
4 to 5: tRCD is waited for and a read command is issued to SDRAM at clock 5. At this time, the column address is given to DRAM ADDR.

7: The first read data is determined. EVALID- is made active, and this data is directly read to the CPU.

8 to 14: Data is read from SDRAM in continuous bursts. During this time, EVALID- to the CPU is made active. A burst stop command is issued during clock 13, and a precharge command is issued during clock 14.

Note If AP = 1 (auto precharge OFF), no precharge command is issued at clock 14.

The DRAM write cycle follows the CPU's output data rate (DDDD or DxxDxxDxxDxx). In the case of DRAM, an active command is issued 3 clocks after the address is determined, and 1 clock later EOK- is returned to start the cycle. The following figure shows an example of the burst cycle with data rate DxxDxxDxxDxx.



The status is described below following the clock number.

0 to 1: The CPU's external write cycle starts. Normally, EOK- is inactive.

2 to 3: The DRAM write cycle is determined, and an active command is issued for SDRAM at clock 3. At this time, the row address is given to DRAM ADDR.

4 to 6: EOK- becomes active 1 clock after the active command, and 2 clocks after EOK-, the CPU's external write cycle starts.

7: The first data output is performed. A write command is issued for SDRAM so that this data can be written directly. The column address is given to DRAM ADDR at this time.

8 to 16: The write operation is repeated. From the second and subsequent writes, the timing is taken from DRAM_CKE to synchronize with the data rate.

17: The burst stop command is issued to SDRAM.

18. The precharge command is issued to SDRAM.

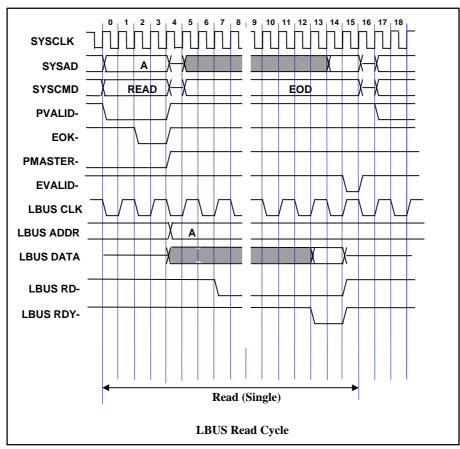
Note When AP = 1 (auto precharge OFF), no precharge command is issued at clock 18.

When AP = 1 (auto precharge OFF), during the interval until precharge is issued, the lower address in SDRAM is temporarily held. If access is performed to the same lower address space in this status (hit), the active command is skipped, so that SDRAM access starts two clock cycles earlier for both the read cycle and the write cycle. However, in the case of non-match (miss hit), precharge must be performed before the target address, so that the overhead increases.

SDRAM refresh uses the CBR (auto) refresh command, and refresh is performed approximately every 15 *ms* through the setting of Timer 2.

8.3. LOCAL BUS ACCESS

The local bus is a sync bus that has a data width of 32 bits and operates at 1/2 SYSCLK.



The following figure shows the read cycle on the local bus.

The status is described below following the clock number.

0 to 1: The CPU's external read cycle starts. Normally, EOK- is inactive.

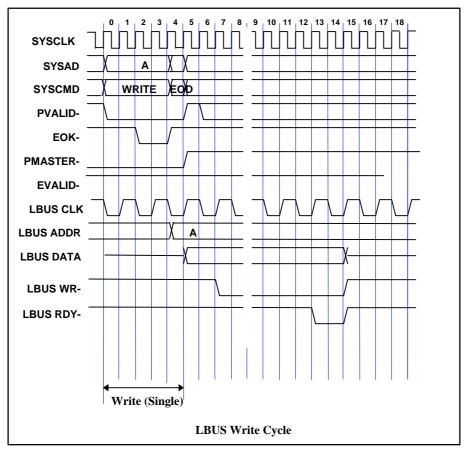
2 to 3: The read cycle to the LBUS is determined, and EOK- becomes active.

6: The read cycle to the LBUS starts.

8 to 9: The clocks in this interval differ according to the accessed resource.

13 to 15: The fact that data has been prepared on the LBUS is indicated by the fact that status becomes active at LBUS RDY.

Data from LBUS is output to SYSAD in synchronization with SYSCLK. Following LBUS RDY, EVALIDis returned to the CPU at clock 15 and the bus operation ends.



The following figure shows the write cycle on the local bus.

The status is described below following the clock number.

0 to 1: The CPU's external write cycle starts. Normally, EOK- is inactive.

2 to 3: The write cycle of the LBUS is determined and EOK- becomes active.

4: Data output is performed. The LBUS controller latches the data at this time. The CPU cycle ends at this point, but the write cycle actually continues.

6. The write cycle to the LBUS starts.

8 to 9: The clocks in this interval differ according to the accessed resource.

13 to 14: The LBUS write cycle ends when LBUS RDY becomes active.

8.4. LIST OF REQUIRED CLOCKS

The following tables list the required number of clocks for memory access.

8.4.1. SRAM Access

Cycle type	1st	2nd	3rd	4th	5th	6th	7th	8th	total	Remark
SingleRead	6 + n								6 + n	SWAIT[] = 0
SingleWrite	5								5	DDDD
8 BurstRead	6 + n	1 + n	1 + n	1 + n	1 + n	1 + n	1 + n	1 + n	13 + 8*n	SWAIT[] = 0
4 BurstWrite	5	1 + n	1 + n	1 + n					8 + 3 *n	DDDD

Note In the read cycle, n = SWAIT[]. In the write cycle, n = 2 for data rate DxxDxx.

8.4.2. SDRAM Access

Cycle type	1st	2nd	3rd	4th	5th	6th	7th	8th	total	Remark
SingleRead	8									
SingleWrite	8									DDDD
8 BurstRead	8	1	1	1	1	1	1	1	15	SWAIT[] = 0
4 BurstWrite	8	1 + n	1 + n	1 + n					11 + 3 *n	DDDD

Notes 1. In the write cycle, n = 2 for data rate DxxDxx.

- 2. When auto precharge is ON, the precharge time following the last cycle is added, but there is no penalty if there are two or more idle cycle clocks by the start of the next cycle from the last cycle.
- **3.** If the auto precharge is OFF, the first cycle of the cycles during which the row address has hit is shorted by 2 clocks. Inversely, in the case of no hit, a precharge cycle is inserted immediately before the 1st cycle, so that 2 clocks are added.

9. ROM PROGRAMMING

Refer to the following section when preparing a program to be placed in ROM on the board.

9.1 INITIALIZATION

In the reset processing routine, following processor register initialization, set Timer 2 for the memory access controller and DRAM refresh.

The following describes board-specific items. For other details, see the manual for the CPU.

<initialization contents="" of="" processor=""></initialization>		
Config Reg	 SW2-4 = OFF >>E	EP = 0x6(DxxDxx)
	SW2-4= ON >>E	EP = 0x0(DDDD)
<sram initialization="" wait=""></sram>		
[0xB8006000+ offset].b <= 0	 SRAM Wait >> 0 v	waits
<sdram controller="" initialization=""></sdram>		
[0xB8005000+ offset].b <= 2	 SDRAM tRCD	>> 2 clocks
[0xB8005010+ offset].b <= 2	 SDRAM tRP :	>> 2 clocks
[0xB8005020+ offset].b <= 5	 SDRAM tRC	>> 5 clocks
[0xB8005030+ offset].b <= 6	 SDRAM tRRC	>> 6 clocks
[0xB8005040+ offset].b <= 4	 SDRAM tRAS	>> 4 clocks
[0xB8005050+ offset].b <= 2	 SDRAM tLAT	>> 2 clocks
[0xB8005060+ offset].b <= 2	 SDRAM tRSC :	>> 2 clocks
[0xB8005070+ offset].b <= 1	 SDRAM AP :	>>Auto precharge: Off (arbitrary)
[0xB8004000+ offset].b <= 0	 SDRAM Mode Re	g Set
<refresh initialization="" timer=""></refresh>		
[0xB9005030+ offset].b <= 0xb4	 Timer 2 Mode 2 (Set to approx. 15 ms cycle)
[0xB9005020+ offset].b <= 0x1f	 Timer 2 lower cour	nt
[0xB9005020+ offset].b <= 0x00	 Timer 2 higher cou	unt

Memo Offset in the case of doing byte access by Big Endian is 3.

9.2 ROM DATA ASSIGNMENT

The remote monitor ROM is configured as four banks. Normally, set <u>SW3-3 to ON</u> to use these four ROM banks as a continuous ROM space.

Since byte row rearrangement is performed by hardware for this board when the big endian is selected, write also big endian code as is with a ROM writer. (Previously, such code had to be written in 16-bit units using higher/lower 8-bit swapping.)

Memo Even if a ROM emulator is used, disable the ROM banks (set SW3-3 to ON).

10. SPECIFIC GBUS SPECIFICATIONS

This chapter describes the usage status of the GBUS for the RTE-VR5432-CB. For general GBUS specifications, see **14 APPENDIX C GBUS COMMON SPECIFICATIONS**.

10.1 OVERVIEW

An overview of the GBUS signal usage status for the RTE-VR5432-CB is provided in the following table.

GBUS signal name	Function	See
GADDR[31:2]	Used as address lines. GADDR [26:31] are not connected.	
GDATA[31:0]	Used as data lines. In a read cycle, the signal that is latched on the rising edge of SYSCLK is supplied to the CPU.	
GCS-[6:0]	Created by the board and output as chip select lines	10.3
GCLK	Connects SYSCLK divided by 2.	
GRESETI-	Output the reset request generated by the board.	7.1
GRESETO-	OR with reset signal on board and connect to Cold Reset*.	7.1
GADS- , GREADY- , GBLAST- , GW/R-	Used as bus control signal.	
GWAITI-	Use as bus control signal.	
GBTERM-	Use as bus control signal.	
GRD- , GWR-	RD- and WR- signal generated from the GBUS control signals are connected.	
GHOLD- , GHLDA-	Not connected.	
GBREQ-	Not connected.	
GDMARQ-[3:0]	Used as DMA request signal.	7.4.10
GDMAAK-[3:0]	Used as DMA acknowledge signal.	7.4.10
GINTO-[3:0]	Used as interrupt request signal.	7.2
GINTI-[1:0]	OUT0 and OUT1 of TIC (<i>m</i> PD71054) are connected to GINTI0- and GINTI1	
GETC[7:0]	Not connected.	
GAHI_EN-	Not connected.	
GMOTHER_DETECT-	Use for ready generation in case of access to GBUS when not connected to JGBUS.	
GUSE_DIRECT_ACC-	Not connected.	
GCLK_LOW-	High when SW2-8 (BGCLK LOW-) OFF, Low when ON.	5.4
GLOCK-[1:0]	Not connected.	

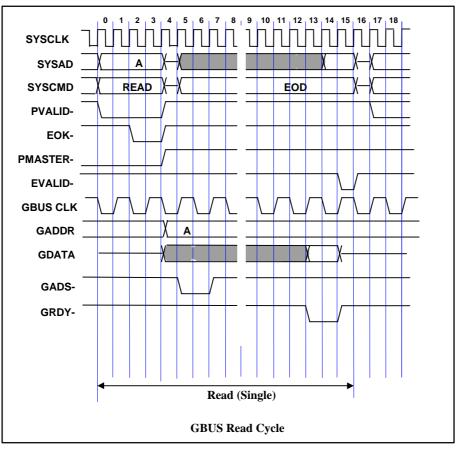
10.2 BUS CYCLE

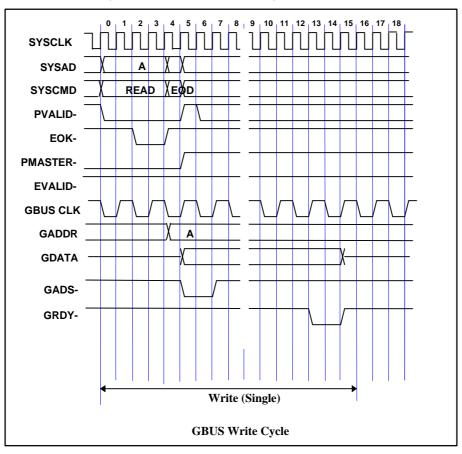
Connect the CPU clock divided by 2 as GCLK to the GBUS. Since GAHI_EN- is not connected, GADDR[26:31] is unconnected.

Both single cycle and burst cycle are supported for GBUS access.

The Gxxx signal is the GBUS signal in the following waveforms.

The read cycle (single) is described in the following table. (For the burst cycle, see 14.6.2 Burst Cycle.)





The write cycle (single) is described in the following table. (For the burst cycle, see 14.6.2 Burst Cycle.)

10.3 CHIP SELECT

The following spaces are assigned for the GBUS chip selects.

GBUS signal name	Logical address range	Physical address range	Remark (RTE-MB-A resources)
GCS0-	0xB0000000 to 0xB0FFFFFF	0x10000000 to 0x10FFFFF	(MB-SRAM)
GCS1-	0xB1000000 to 0xB1FFFFFF	0x11000000 to 0x11FFFFFF	FBOOT=OFF (MB-FLASH)
	0xBF000000 to 0xBFFFFFFF	0x1F000000 to 0x1FFFFFFF	FBOOT=ON (MB-FLASH)
GCS2-	0xB2000000 to 0xB2FFFFFF	0x12000000 to 0x12FFFFFF	(MB-Peri)
GCS3-	0xB3000000 to 0xB3FFFFFF	0x13000000 to 0x13FFFFFF	(MB-EXT-MEM)
GCS4-	0xB4000000 to 0xB4FFFFFF	0x14000000 to 0x14FFFFFF	(MB-EXT-IO)
GCS5-	0xB5000000 to 0xB5FFFFFF	0x15000000 to 0x15FFFFFF	(MB-PCI Bus)
GCS6-	0xB6000000 to 0xB6FFFFFF	0x16000000 to 0x16FFFFF	(MB-PCI9080 Reg)

Uncached areas are described for the physical addresses. If access is performed as cached areas, subtract 0x20000000. While it is possible to perform burst access for the resources of this board as cached areas, use the I/O space and common memory space on an uncached basis.

11. APPENDIX A MULTI MONITOR

This chapter describes how to make the settings required to establish a connection between the Multi monitor stored in ROM and the Multi debugger on the host. It also provides notes on the use of the Multi monitor.

11.1. BOARD SETTING

11.1.1. RTE for Win 32 Installation

When the board is used with the Multi debugger, communication software called RTE for Win32 must be installed in the PC. Refer to the RTE for Win32 Installation Manual (supplied with this product) for installation and test methods.

11.1.2. SW1 Setting

SW1 is a switch for general-purpose input ports. For the Multi monitor in the factory-installed ROM, SW1 is used as shown below. Be sure to use the correct setting.

SW1	1	2	Baud rate	
Setting	ON	ON	115,200 baud	
	OFF	ON	38,400 baud	
	ON	OFF	19,200 baud	
	OFF	OFF	9,600 baud	(Factory-set)

Baud Rate Setting

SW1	3	4	Profiler period	
Setting	ON	ON	Timer is not used.	
	OFF	ON	200 Hz 5 ms	
	ON	OFF	100 Hz 10 ms	
	OFF	OFF	60 Hz 16.67 ms	(Factory-set)

Profiler Period Setting

SW1	8	Debugger mode
Setting	ON	Monitor uses 7-segment LED
	OFF	Normal use state (Factory-set)

Debug Mode Setting

SW1-5 to SW1-7 are not used with the Multi monitor.

11.1.3. Connection of Board

Connect the board to the PC serially, by referring to 6 CONNECTION WITH THE HOST PC.

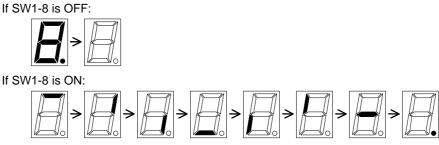
11.2. MULTI MONITOR

The ROM monitor for Multi can be executed in any one of four modes: 32-bit big endian, 32-bit little endian, 64-bit big endian, and 64-bit little endian. The monitor operating mode depends on the SW3-7:8 settings.

11.2.1. 7-Segment LED on Startup

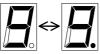
The 7-segment LED of the ROM monitor for Multi operates as follows when power is supplied to the board (black indicates the segment that lights).

1) Check operation of 7-segment LED (See figure below.)

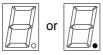


Number counting by simple SRAM memory check
 * Not executed if SW1-8 is OFF.

3) Connection wait status (The dot does not blink if the profiler timer is stopped.)



4) Connection status (The status of the dot is retained on connection.)



11.2.2. Monitor Work RAM

The ROM monitor uses the first 64 Kbytes (from the start address to 1000H) in the SRAM (uncached) as work RAM (reserved). In other words, <u>user programs are not allowed to use logical addresses</u> 8000-0000H to 8000-FFFFH and A000-0000H to A000-FFFFH, nor their image area.

11.2.3. Interrupt

The INT0 interrupt is used for the monitor. The vector for this interrupt is BFC0-0380H of ROM by bootstrap (BEV = 1) setting. Therefore, it is not possible to overwrite the vector. With the monitor, it is possible to overwrite the vector by branching once to a substitute vector securing A000 to 0180H of the SRAM (uncached).

11.2.4. _INIT_SP Setting

_INIT_SP (stack pointer initial value) is set to 4F7FF0H (immediately before monitor work RAM) by the monitor. (_INIT_SP can be changed in the Multi environment.) The monitor uses a 32-byte stack area set by the user program.

11.2.5. Timer Interrupt

If the timer interrupt is disabled, the profiler function of Multi cannot be used (for how to set the timer interrupt, see **11.1.2 SW1 Setting**).

11.2.6. Initializing Hardware

The ROM monitor performs initialization so that the resources on the board can be directly accessed.

11.2.7. Special Instruction

The monitor uses the following instruction for the single step, breakpoint, and system call functions.

BREAK instruction (0xxxxxdh)

Do not use a code that may be interpreted as a break instruction in the user program.

11.3. RTE COMMANDS

When the monitor and MIDAS server (RTESERV) are connected by the Multi debugger, the TARGET window is opened. The RTE commands can be issued in this window. The following table lists the RTE commands.

Command	Description
HELP, ?	Displays help messages.
INIT	Initializes.
VER	Displays the version number.
CACHEFLUSH	Flushes the cache
SHOWTLB	Displays the contents of the TLB
IOREAD	Reads the I/O (size specification)
IOWRITE	Writes to the I/O (size specification)

RTE Commands

Some commands require parameters. All numeric parameters such as addresses and data are assumed to be hexadecimal numbers. The following numeric representations are invalid: 0x1234 1234H \$1234

11.3.1. HELP(?)

<Format> HELP [command-name]

Displays a list of RTE commands and their formats. A question mark (?) can also be used in place of the character string HELP. If no command name is specified in the parameter part, the HELP command lists all usable commands.

<Example> HELP INIT Displays help messages for the INIT command.

11.3.2. INIT

<Format> INIT

Initializes the RTE environment. Usually, this command should not be used.

11.3.3. VER

<Format> VER Displays the version number of the current RTE environment.

11.3.4 CACHEFLUSH

<Format> CACHEFLUSH Flushes the cache contents of the CPU.

11.3.5 SHOWTLB

<Format> SHOWTLB Displays in list form the TLB contents of the CPU.

11.3.6 IOREAD

<Format> IOREAD [BYTE|SHORT|LONG] [address]

Reads the address memory of the specified size and displays this data. The size can be specified as 8, 16, and 32 bits with BYTE, SHORT, and LONG, respectively. This command is used for memory mapped I/O access.

<Example> IOREAD BYTE 0xBC000100 BC000100: 1A

11.3.7 IOWRITE

<Format> OWRITE [BYTE|SHORT|LONG] [data] [address]

Writes data to the address memory of the specified size. The size can be specified as 8, 16, and 32 bits with BYTE, SHORT, and LONG, respectively. This command is used for memory mapped I/O access.

<Example> OWRITE SHORT 0x30F0 0xBC00F000

12. APPENDIX B PARTNER MONITOR

This chapter describes how to make the settings required to establish a connection between the PARTNER monitor stored in ROM and the PARTNER on the host. It also provides notes on the use of the PARTNER monitor.

12.1. BOARD SETTING

12.1.1. SW1 Setting

SW1 is a switch for general-purpose input ports. For the PARTNER monitor in the factory-installed ROM, SW1 is used as shown below. Be sure to use the correct setting.

SW1	1	2	Baud rate	
Setting	ON	ON	115,200 baud	
	OFF	ON	38,400 baud	
	ON	OFF	19,200 baud	
	OFF	OFF	9,600 baud	(Factory-set)

Baud Rate Setting

SW1	3	4	Timer
Setting	ON	ON	Always use this switch in this status.

SW1	8	Debugger mode	
Setting	ON	Monitor uses 7-segment LED	
	OFF	Normal use state	(Factory-set)

Debug Mode Setting

SW1-5 to SW1-7 are not used with the PARTNER monitor.

12.1.2. Connection of Board

Connect the board to the PC serially, by referring to 6 CONNECT WITH THE HOST PC.

12.2 PARTNER MONITOR

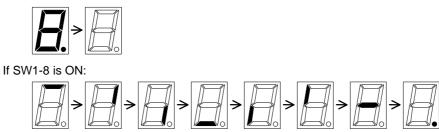
The partner ROM monitor can be executed using one of two modes: 32-bit big endian or 32-bit little endian. The monitor operation mode depends on the SW3-7:8 settings.

12.2.1. 7-Segment LED on Startup

The 7-segment LED of the ROM monitor for PARTNER operates as follows when power is supplied to the board (black indicates the segment that lights).

1) Check operation of 7-segment LED (See figure below.)

If SW1-8 is OFF:



- 2) Number counting by simple RAM memory check
 - * Not executed if SW1-8 is OFF.
- 3) Connection wait status



4) Connection status



12.2.2. ROM Monitor Work RAM

The ROM monitor uses the first 64 Kbytes (from the start address to 10000H) in the SRAM as work RAM (reserved). In other words, <u>user programs are not allowed to use logical addresses 8000-0000H to 8000-FFFFH and A000-0000H to A000-FFFFH, nor their image area</u>.

12.2.3. Interrupt

The INT0 interrupt is used as the interrupt for monitor communication and forcible breaks (ESC button). The vector for this interrupt is BFC0-0380H of ROM by bootstrap (BEV = 1) setting. Therefore, it is not possible to overwrite the vector. With the monitor, it is possible to overwrite the vector by branching once to a substitute vector securing A000 to 0180H of the SRAM (uncached).

12.2.4. INIT_SP Setting

The initial value of the monitor's stack pointer is set to A003-FFF0H (highest in SRAM). This value can be changed with the INIT_SP command defined in the partner's configuration file. The monitor uses the 32-byte stack area set with the user program.

12.2.5. Remote Connection

The connection with the debugger is of the serial type. Correctly set the SW1 communication speed setting and the setting of the communication speed with the transmission channel with RPTSETUP.

12.2.6. Initializing Hardware

The ROM monitor performs initialization so that the resources on the board can be directly accessed.

12.2.7. Special Instruction

The monitor uses the following instruction for the single step, breakpoint, and system call functions.

BREAK instruction (0xxxxxdh)

Do not use a code that may be interpreted as a break instruction in the user program.

13. APPENDIX C INTERRUPT PROGRAMMING

This appendix describes interrupt processing in user programs using the monitor.

13.1. INTERRUPT LIBRARY

Since, in the VR5432, a vector is assigned for general exception interrupts as a group and interrupts are used even in the monitor, this vector is used in common. An interrupt library (attached sample program: Intvect.c, IntHdr.s/mip) is provided.

This library hooks vectors and is table managed for every exception for exception processing routine execution. The eight provided library functions are described below.

13.1.1. int InitIrqVect(void)

Performs interrupt vector hooking and table initialization. Upon normal end, 0 is returned, and in case of an error, a negative error number is returned.

13.1.2. int TermIrqVect(void)

Returns an interrupt vector. Upon normal end, 0 is returned, and in case of an error, a negative error number is returned.

13.1.3. int SetIrqVect(int no, int func)

Registers (casts with int type) the function func to the interrupt processing table specified by argument No. An item defined as a macro in the VECT_IPn format in the Intvect.h file is used.

When 0 is specified for func, the previously set processing routine becomes invalid. Upon normal end, 0 is returned, and in the case of an error, a negative error number is returned.

13.1.4. int GetlrqVect(int no)

Returns the function address registered to the interrupt processing tabled specified with the argument No. If 0, this indicates that there is no registered function. If an error occurs, a negative error number (odd) is returned.

13.1.5. void SetIPnBit(int IPn)

Enables interrupts specified with argument IPn. (The corresponding bit of the status register is set to "1.")

13.1.6. void ResIPnBit(int IPn)

Disables interrupts specified with argument IPn. (The corresponding bit of the status register is set to "0.")

13.1.7. void ei(void)

Enables all interrupts.

13.1.8. void di(void)

Disables all interrupts except NMI.

13.2. INTERRUPT ROUTINE

The user-defined interrupt processing routines assume an int type C function (no ___interrupt modifier used). Moreover, to correctly debug the interrupt processing routine, disable the interrupt corresponding to the start of the interrupt processing routine and enable the interrupt prior to ending. 0 is returned upon the completion of processing, and a value other than 0 is returned when the operation is returned to the monitor.

13.3. SAMPLE PROGRAM

A sample program when performing interrupt processing using user INT1 (IP3) is described below.

```
#include "intvect.h"
int main( void )
{
/* --- can not Break & Step --- */
         di();
                                                      /* disable all interrupt */
         InitIrqVect();
                                                      /* save original vector code & set new vector */
          SetIrqVect( VECT_IP3, (int)IrqHusr );
                                                      /* set function vector table */
          SetIPnBit( SR_IP3 );
                                                      /* set IP3 bit */
                                                      /* enable all interrupt */
          ei();
/*
  ---- */
                                                      /* process */
/* --- can not Break & Step --- */
                                                      /* disable all interrupt */
          di();
          ResIPnBit( SR_IP3 );
                                                      /* reset IP3 bit */
          SetIrqVect( VECT_IP3, 0);
                                                      /* remove vector */
         TermIrqVect();
                                                      /* restore original vector code */
          ei();
                                                      /* enable all interrupt */
/*
  --- --- */
          exit;
3
/*** irqHusr ***/
int IrqHusr( struct _irq_stack *istack )
{
                                                      /* flag */
         int to_monitor;
/* --- can not Break & Step --- */
         ResIPnBit( SR_IP3 );
                                                      /* Disable INT1 interrupt */
                                                      /* Enable multiple interrupt */
          ei();
/* ---- */
                    /* interrupt operation */
/* --- can not Break & Step --- */
         di();
          SetIPnBit( SR_IP3 );
                                                      /* Enable INT1 interrupt */
         If( to_monitor != 0 ) {
                    return 1;
                                                      /* request monitor handler */
         }
         return 0;
                                                      /* normal end */
}
```

14. APPENDIX C GBUS COMMON SPECIFICATIONS

This appendix explains the GBUS specifications that are not dependent on the type of board.

14.1. TERMINOLOGY

Terminology used in this appendix is explained below.

14.1.1. CPU Board and Motherboard

A board in the RTE-CB series is called a CPU board and a Midas lab board connected to GBUS of the CPU board is called a motherboard.

14.1.2. Bus Cycle and Micro Cycle

GBUS is a general bus that can be accessed in burst mode.

A bus cycle consists of a series of cycles, including a one in which a burst access occurs, that is completed (asserting of GADS- is necessary to mark the end of a bus cycle).

Bus cycles are classified into single cycles and a burst cycles. A single cycle is a bus cycle in which data transfer occurs only once. A burst cycle is a bus cycle in which data transfer occurs two or more times.

One cycle for each data transfer in a burst cycle is called a micro cycle.

14.2. SIGNALS

The GBUS signals are listed below. <u>The input/output direction of each GBUS signal is indicated as</u> viewed from the motherboard. Therefore, "input" means that a signal output from the CPU board is input to the motherboard (this also applies to signal names).

"Bidirectional" signals change direction depending on the status of the bus cycle.

"Input/output" signals also change direction depending on whether the bus master is the CPU board or motherboard. The direction written first is the signal direction when the CPU board is the bus master, and the direction written later is the signal direction when the motherboard is the bus master. A GBUS signal is a +5-V TTL level signal. The motherboard is always little endian

	A GBOS signal is a +5-V TTE level signal. <u>The motherboard is always little endian.</u>				
Signal name	Input/output	Function			
GCLK	Input	 Synchronization clock of GBUS. The maximum frequency is 33.33 MHz, and the minimum frequency is 10.0 MHz. GBUS operates synchronized with the rising edge of this clock. Since, on the motherboard, this clock is terminated at 330 Ω with respect to +5V and GND, the circuit on the CPU board must be able to drive this resistance. If GCLK is less than 16.67 MHz, GCLK_LOW- goes low. In this way, the motherboard can adjust the number of wait cycles. Because a PLL (Phase Lock Loop) zero delay buffer may be used, if the frequency of GCLK is changed, the motherboard must not be accessed for at least 1 ms after the frequency has been changed to allow the PLL to be locked. 			
GRESETI-	Input	• Reset signal of GBUS. If a reset occurs on the CPU board, this signal goes low. The motherboard is reset by this signal (the motherboard can also be reset for other causes on the motherboard).			
GRESETO-	Output	 This signal goes low if the motherboard is reset. The motherboard ORs the reset signal on the motherboard with GRESETI- as GRESETO Accordingly, the CPU board resets the circuits on the CPU board by ORing GRESETI- and GRESETO- (GRESETI- and GRESETO- are ORed because there is a possibility that the motherboard is not connected). 			

Signal name	Input/output	Function
GADDR[31:2]	Input/output	 Address signals of GBUS. These signals are driven by a valid value during a cycle. GADDR[31] is ignored on the motherboard if the CPU is the bus master. The low-order addresses A1 and A0 use a byte enable signal. GADDR[31:26] from the CPU board can be treated as 0 by using the GAHI_EN- signal. If the bus master is the motherboard and if GADDR[25] is 0, the resources on the motherboard are selected; if GADDR[25] is 1, the resources on the CPU board is selected.
GBEN-[3:0]	Input/output	 Byte enable signals of GBUS. These signals are always driven by a valid value during a cycle. GBEN0-, GBEN1-, GBEN2-, and GBEN3- correspond to byte lanes GDATA[7:0], GDATA[15:8], GDATA[23:16], and GDATA[31:24], and the corresponding byte lane is valid if GBENx- is low.
GDATA[31:0]	Bidirectional	 Bus data signals of GBUS. These signals are pulled up to 10 kΩ on the motherboard. The direction of these signals is determined by GW/R
GADS-	Input/output	 Address strobe signal of GBUS. If this signal is sampled low on the rising edge of GCLK, the start of a bus cycle is indicated. The motherboard ignores GADS- if none of the chip select signals (GCS-[7:0]) is active.
GREADY-	Output/input	 Ready signal of GBUS. If this signal is sampled low and GWAITI is sampled high on the rising edge of GCLK during a micro cycle, the end of the micro cycle is indicated. Time-over ready when the CPU board accesses the motherboard is generated by the motherboard. The reason is to avoid collision with the GREADY- signal.
GWAITI-	Input	 Wait request signal. This signal is sampled on the rising edge of GCLK. If the CPU board cannot support a cycle with a few wait cycles, the CPU board samples GWAITI- low at the sample timing of GREADY- so that the motherboard cannot handle GREADY- as a ready signal even though it is low at the time. Usually, this signal is used if the CPU board cannot support zero wait burst (see 14.6.3 GWAITI-). This signal is valid only in a cycle in which the CPU board is the bus master.
GBLAST-	Input/output	 Bus cycle completion notification signal. This signal is sampled on the rising edge of GCLK. This signal is asserted low by the bus master when a micro cycle that completes the bus cycle starts. The bus cycle is completed if the low level of GBLAST-, low level of GREADY-, and high level of GWAITI- are sampled on the rising edge of GCLK.
GBTERM-	Output/input	 Bus cycle completion request signal. This signal is sampled on the rising edge of GCLK. If the accessed side requests completion of the bus cycle, the GREADY- and GBTERM- signals go low. If the bus master samples GBTERM- as low when it samples GREADY- as low, it must complete the bus cycle even though GBLAST- has not been asserted, and start the bus cycle again by asserting GADS- again. GBTERM- must be asserted at the same time as GREADY This signal is used to complete the bus cycle if the accessed side does not support burst cycles or if a burst cycle exceeding the supported number of bursts is requested.

Signal name	Input/output	Function		
GW/R-	Input/output	 Write/Read signal. This signal indicates the direction of the data bus. It is always driven by a valid value during the bus cycle. This signal indicates the direction of the data bus for the bus master. 		
GCS-[7:0]	Input	 Chip select signals. These signals are always driven by a valid value during the bus cycle. The CPU board makes the corresponding chip select signal active to specify the resources on the motherboard when the CPU board is the bus master. Each chip select signal specifies the type of memory/I/O space and the width of the space (see 14.5 ALLOCATING GCS-[7:0]). 		
GRD-	Input	 Read timing signal. This signal is asserted when the CPU board is the bus master. This signal is not used by the motherboard. If the CPU has an RD- command signal, that signal is usually connected. 		
GWR-	Input	 Write timing signal. This signal is asserted when the CPU board is the bus master. This signal is not used by the motherboard. If the CPU has a WR- command signal, that signal is usually connected. 		
GHOLD-	Output	 Bus hold request signal. This signal is asserted low when the motherboard accesses the resources on the CPU board to acquire bus mastership. If the GUSE_DIRECT_ACC- signal is high, the GHOLD- signal indicates to the CPU board that the motherboard has no resources that can be accessed. In this case, the CPU board does not have to support GHOLD 		
GHLDA-	Input	 Bus hold acknowledge signal. This signal indicates that the CPU board releases bus mastership of GBUS to the motherboard. It is then asserted low. The CPU board that asserts the GUSE_DIRECT_ACC- signal high can disconnect the GHLDA- signal. 		
GBREQ-	Input	 Bus mastership release request signal When the motherboard has bus mastership from asserting GHLDA- low, the CPU board asserts GBREQ- low when it requires bus mastership. If GBREQ- is asserted low and the motherboard is in bus cycle, GBLAST-must be asserted in the next micro cycle, the bus cycle must be completed in the next micro cycle, and GHOLD- must be deasserted. GBREQ- is used to return bus mastership to the CPU board temporarily if the number of bursts in the bus cycle is large when the motherboard is the bus master, or if a bus cycle with a high priority such as a refresh cycle is pending on the CPU board. 		
GDMARQ- [3:0]	Output	 DMA request signals. Only two-cycle DMA is supported. Fly-by DMA is not supported. These signals are asserted low if a DMA request is generated on the motherboard. The CPU board must support all four DMA signals. The number of DMA signals that can be asserted at the same time and can be supported by the GDMAAK- signal depends on the CPU board. The CPU board uses the DMAAK signal in preference to DMAAK-[3:2] if correspondence between all four GDMARQ- signals and GDMAAK- signals cannot be established. 		

Signal name	Input/output	Function
GDMAAK- [3:0]	Input	 DMA acknowledge signals. These signals are asserted low to acknowledge DMA requests from the motherboard. The CPU board uses the DMAAK signal in preference to DMAAK-[3:2] if correspondence between all four GDMARQ- signals and GDMAAK- signals cannot be established. The motherboard is designed to operate even though there is no GDMAAK-signal.
GINTO-[3:0]	Output	 Interrupt request signals. GINTO0- can be used as a level-sensitive signal. Whether GINTO-[3:1] can be used as level-sensitive signals or edge-sensitive signals depends on the CPU board (since they may be directly connected to the CPU). The motherboard can support both level- and edge-sensitive signals. Occurrence of an interrupt is indicated when these signals are low or on the falling edges of these signals.
GINTI-[1:0]	Input	 Interrupt request signals. These interrupt signals are used to combine an interrupt on the CPU board with an interrupt on the other motherboard and return the combined signal to GINTO-[3:0]. Usually, OUT0 and OUT1 of TIC (<i>m</i>PD71054) on the CPU board are connected. The motherboard can select the type of sensitivity and polarity of these interrupt signals.
GETC[7:0]		 CPU board dependent signals. The contents of GETC[7:0], including the direction and contents of the signals, are determined by the CPU board. The CPU board uses these signals to exchange special signals with the motherboard.
GAHI_EN-	Input	 Upper address valid signal. If this signal is low and if the CPU board is the bus master, the CPU board drives a valid value on GADDR[31:26]. If this signal is high, the CPU board does not drive a valid signal on GADDR[31:26], and the circuits on the motherboard perform processing with all of GADDR[31:26] low.
GMOTHER_ DETECT-	Output	 Motherboard detection signal. This signal is pulled up on the CPU board, and is connected to GND on the motherboard. The CPU board uses this signal when it must determine if the motherboard is connected (for example, time-over ready generation circuit of the CPU board).
GUSE_ DIRECT_ACC-	Input	 If this signal is low, the CPU board has resources that can be accessed by the motherboard.
GCLK_LOW-	Input	 If this signal is low, the frequency of GCLK is 16.67 MHz or less. If it is high, the frequency of GCLK is 16.67 to 33.33 MHz. The circuits on the motherboard use this signal to determine the number of wait cycles required for accessing the resources on the motherboard.
GBLOCK-[1:0]	Input	 Bus lock signals. These signals must be valid during a bus cycle and for bus cycles that must be locked. If a bus lock signal is output by the CPU, the bus lock signal is connected to the motherboard using these pins. The GBLOCK0- signal is valid for the GCS0- space. GBLOCK1- is valid for the GCS5- and GCS7- spaces.
+5V	Output	\bullet Power supply. Supplies +5 V $\pm5\%$ from the motherboard to the CPU board.

Signal name	Input/output	Function		
+12V	Output	\bullet Power supply. Supplies +12 V ±10% from the motherboard to the CPU board.		
		However, if the CPU board does not require +12 V, the motherboard does not		
		have to supply +12 V.		

14.3. PIN ASSIGNMENTS

The following table shows the GBUS pin assignments. Reserve indicates a reserved pin. N/C indicates that a pin is not connected.

No.	Signal name	No.	Signal name	No.	Signal name	No.	Signal name
1	+12V	2	+12V	3	GND	4	+5V
5	GADDR2	6	GADDR3	7	GADDR4	8	GADDR5
9	GADDR6	10	GADDR7	11	GND	12	+5V
13	GADDR8	14	GADDR9	15	GADDR10	16	GADDR11
17	GADDR12	18	GADDR13	19	GADDR14	20	GADDR15
21	GND	22	+5V	23	GADDR16	24	GADDR17
25	GADDR18	26	GADDR19	27	GADDR20	28	GADDR21
29	GADDR22	30	GADDR23	31	GND	32	+5V
33	GADDR24	34	GADDR25	35	GADDR26	36	GADDR27
37	GADDR28	38	GADDR29	39	GADDR30	40	GADDR31
41	GND	42	+5V	43	GBEN3-	44	GBEN2-
45	GBEN1-	46	GBEN0-	47	GND	48	+5V
49	GDATA31	50	GDATA30	51	GDATA29	52	GDATA28
53	GDATA27	54	GDATA26	55	GDATA25	56	GDATA24
57	GND	58	+5V	59	GDATA23	60	GDATA22
61	GDATA21	62	GDATA20	63	GDATA19	64	GDATA18
65	GDATA17	66	GDATA16	67	GND	68	+5V
69	GDATA15	70	GDATA14	71	GDATA13	72	GDATA12
73	GDATA11	74	GDATA10	75	GDATA9	76	GDATA8
77	GND	78	+5V	79	GDATA7	80	GDATA6
81	GDATA5	82	GDATA4	83	GDATA3	84	GDATA2
85	GDATA1	86	GDATA0	87	GND	88	+5V
89	GND	90	GW/R-	91	GBTERM-	92	GREADY-
93	GRESETI-	94	GADS-	95	GBLAST-	96	GWAITI-
97	GND	98	GCLK	99	GND	100	+5V
101	GCS0-	102	GCS1-	103	GCS2-	104	GCS3-
105	GCS4-	106	GCS5-	107	GCS6-	108	GCS7-
109	Reserve	110	Reserve	111	Reserve	112	Reserve
113	GRD-	114	GWR-	115	GND	116	+5V
117	GHOLD-	118	GHLDA-	119	GBREQ-	120	N/C
121	GDMARQ0-	122	GDMARQ1-	123	GDMARQ2-	124	GDMARQ3-
125	GDMAAK0-	126	GDMAAK1-	127	GDMAAK2-	128	GDMAAK3-
129	Reserve	130	Reserve	131	Reserve	132	Reserve
133	GND	134	+5V	135	GINTO0-	136	GINTO1-
137	GINTO2-	138	GINTO3-	139	GINTI0-	140	GINTI1-
141	GETC0	142	GETC1	143	GETC2	144	GETC3
145	GETC4	146	GETC5	147	GETC6	148	GETC7
149	Reserve	150	Reserve	151	GAHI_EN-	152	GMOTHER_DETECT-
153	GND	154	+5V	155	GUSE_DIRECT_ACC-	156	GCLK_LOW-
157	GRESETO-	158	GBLOCK0-	159	GBLOCK1-	160	N/C
161	N/C	162	N/C	163	N/C	164	N/C
165	N/C	166	N/C	167	N/C	168	N/C
169	N/C	170	N/C	171	N/C	172	N/C
173	N/C	174	N/C	175	N/C	176	N/C
177	GND	178	+5V	179	+12V	180	+12V

The following connectors are used:

CPU board side connector	\rightarrow	KEL 8817-180-170L
Motherboard side connector (straight)	\rightarrow	KEL 8807-180-170S
Motherboard side connector (L angle)	\rightarrow	KEL 8807-180-170L

14.4. PROCESSING OF UNUSED PINS

Signals that are not input to the GBUS motherboard are pulled up or down on the motherboard and can be unconnected on the CPU board. Signals that can be unconnected and the processing performed on the motherboard for those pins are shown below.

Signal name	Processing
GADDR[31:26]	• If GADDR[31:26] are not used, GADDR[31:26] can be unconnected by making the GAHI_EN- signal high or by disconnecting it. In this case, if the CPU is the bus master, all the bits of GADDR[31:26] are treated as 0 on the motherboard.
GWAITI-	Pull-up processing is performed.
GBLAST-	Pull-up processing is performed.
GBTERM-	Pull-up processing is performed.
GCS-[7:0]	Pull-up processing is performed.
GHLDA-	Pull-up processing is performed.
GBREQ-	Pull-up processing is performed.
GDMAAK-[3:0]	Pull-up processing is performed.
GINTI-[1:0]	Pull-up processing is performed.
GAHI_EN-	Pull-up processing is performed.
GUSE_DIRECT_ACC-	Pull-up processing is performed.
GCLK_LOW-	Pull-up processing is performed.
GBLOCK-[1:0]	Pull-up processing is performed.

14.5. ALLOCATING GCS-[7:0]

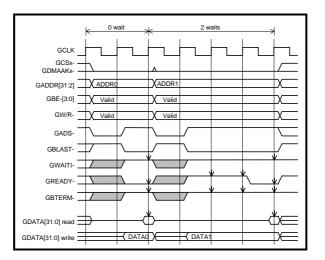
The following table shows the allocation of the chip select signals (GCS-[7:0]). All of the spaces can be accessed in a burst cycle. A space marked I/O under the heading "Recommended space" means that, if the CPU has an I/O space, it is recommended that the space be allocated as an I/O space. "Minimum range" indicates that the CPU board must allocate at least the indicated area for the corresponding chip select space. "Maximum range" indicates that, if the CPU board has an extra address range, addresses can be allocated for the indicated range.

Signal name	Recommended space	Minimum range	Maximum range	Remark
GCS0-	Memory	1 Mbyte		Bus lock possible with GLOCK0-
GCS1-	Memory	2 Mbytes		Because a flash ROM is allocated to this space on the motherboard, the program must be able to be booted from this space, instead of from UV-EPROM on the CPU board, via a switch.
GCS2-	I/O	64 Kbytes		
GCS3-	Memory	64 Kbytes	16 Mbytes	
GCS4-	I/O	64 Kbytes	16 Mbytes	
GCS5-	Memory	1 Mbyte	2 Gbytes	Bus lock possible with GLOCK1-
GCS6-	I/O	512 bytes		
GCS7-	I/O	64 Kbytes	2 Gbytes	Bus lock possible with GLOCK1-

14.6. BUS CYCLE

14.6.1. Single Cycle

The following chart shows the single cycle when GBWAITI- and GBTERM- are always inactive and the CPU board is the bus master. If the motherboard is the bus master, the GCSx-, GDMAAK-, and GWAITI- signals are not used.

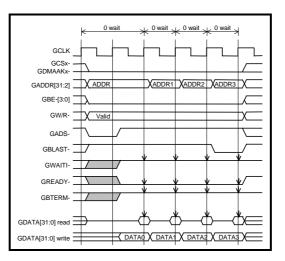


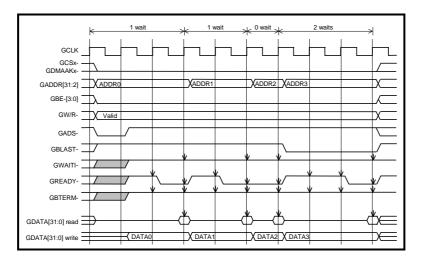
14.6.2. Burst Cycle

The following rules apply to a burst cycle:

- The addresses in the burst cycle can be in any sequence allowed by the GBUS specifications. However, the address sequence may be specified according to what is to be accessed.
- In a burst cycle, all of GBE-[3:0] must be active.
- The number of bursts (the number of micro cycles) is not limited. If the target of the access limits the number of bursts, use the GBTERM- signal (see 14.6.4 GBTERM-) to request canceling of the burst.

The following charts show the burst cycle when GBWAITI- and GBTERM- are always inactive and the CPU board is the bus master. If the motherboard is the bus master, the GCSx-, GDMAAK-, and GWAITI- signals are not used.





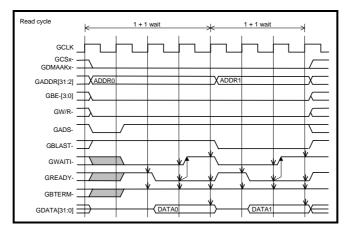
14.6.3. GWAITI-

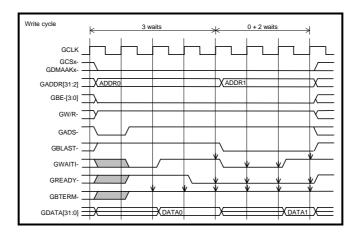
The GWAITI- signal can be used as follows in a cycle in which the CPU board is the bus master:

- To delay sampling of data by a specific number of clocks because the data cannot be sampled in the read cycle.
- To hold the target of an access by the specific number of clocks because data for the next micro cycle is not ready immediately after completion of the first micro cycle in the burst cycle of a write cycle.

In other words, the roles of the read cycle and write cycle are switched, but GREADY- and GWAITIserve as data transmission ready and data reception ready signals.

The following charts show that a wait cycle is inserted by the GWAITI- signal.



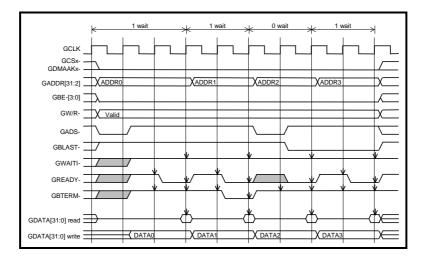


14.6.4. GBTERM-

If both the GBTERM- signal and GREADY- signal become active at the same time, the bus master completes the bus cycle after the current micro cycle ends, and then starts the burst cycle again by asserting GADS- active.

The GBTERM- signal is asserted active if the target of the access does not support burst cycles or accesses are made more than the supported number of bursts. Asserting the GBTERM- signal only without also asserting the GREADY- signal is not allowed.

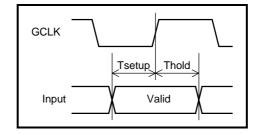
The following chart shows that the burst cycle is canceled by the GBTERM- signal.



14.7. TIMING

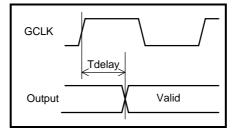
This chapter describes the timing of Midas lab's motherboard. The CPU board is designed to satisfy this timing.

14.7.1. Setup Time



Signal name	Tsetup Min. (ns)	Thold Min. (ns)
GADDR[31:2]	12	0
GBEN-[3:0]	8	0
GDATA[31:0]	7	0
GADS-	14	0
GREADY-	9	1
GWAITI-	14	0
GBLAST-	8	0
GBTERM-	8	1
GW/R-	10	0
GCS-[7:0]	14	0
GBREQ-	15	0
GDMAAK-[3:0]	6	0
GLOCK-[1:0]	12	0

14.7.2. Delay Time



Signal name	Tdelay Max. (ns)
GADDR[31:2]	21
GBEN-[3:0]	17
GDATA[31:0]	21
GADS-	15
GREADY-	15
GBLAST-	17
GBTERM-	16
GW/R-	15

- Memo -

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